

Surface Mount Superfast Recovery Rectifier

Reverse Voltage – 50 to 600 V Forward Current –2 A

FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

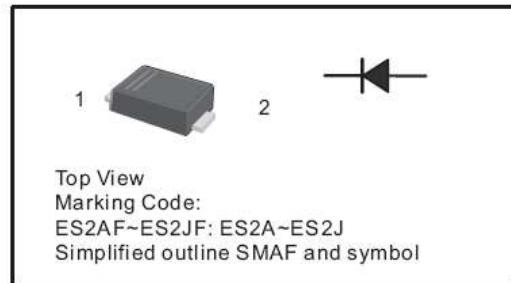
- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- pprox. Weight: 27mg 0.00086oz

Absolute Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Parameter	Symbols	ES2AF	ES2BF	ES2CF	ES2DF	ES2EF	ES2GF	ES2JF	Units		
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	V		
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V		
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	V		
Maximum Average Forward Rectified Current at $T_L = 100^\circ C$	$I_{F(AV)}$	2						A			
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	50						A			
Maximum Forward Voltage at 2A	V_F	1			1.25		1.7	V			
Maximum DC Reverse Current $T_a = 25^\circ C$ $T_a = 125^\circ C$	I_R	5 100						μA			
Typical Junction Capacitance at $V_R=4V$, $f=1MHz$	C_J	60						pF			
Maximum Reverse Recovery Time at $I_F=0.5A$, $I_R=1A$, $I_{rr}=0.25A$	t_{rr}	35						ns			
Operating and Storage Temperature Range	T_J , T_{stg}	-55 ~ +150						$^\circ C$			

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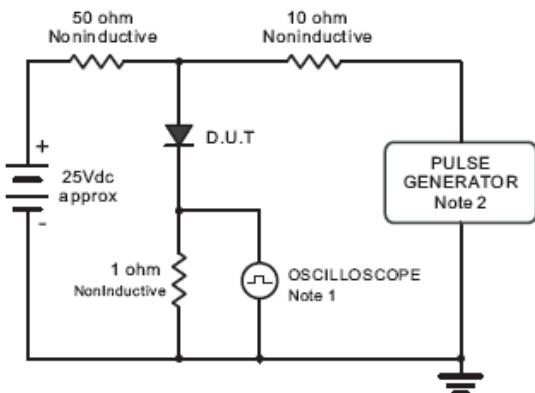
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Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
 Input Impedance = 1megohm,22pF.
 2. Ries Time =10ns, max.
 Source Impedance = 50 ohms.

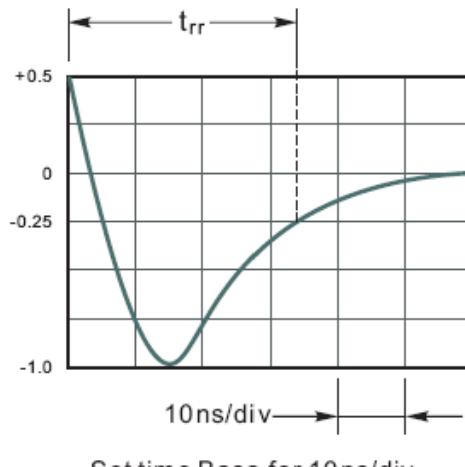


Fig.2 Maximum Average Forward Current Rating

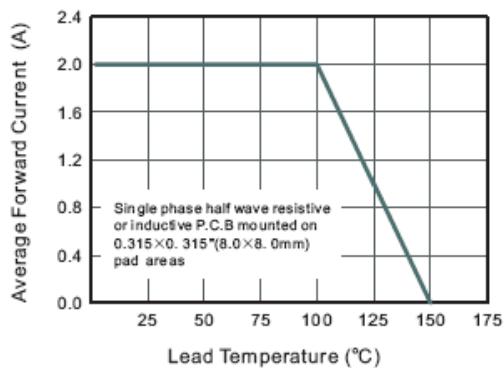


Fig.4 Typical Forward Characteristics

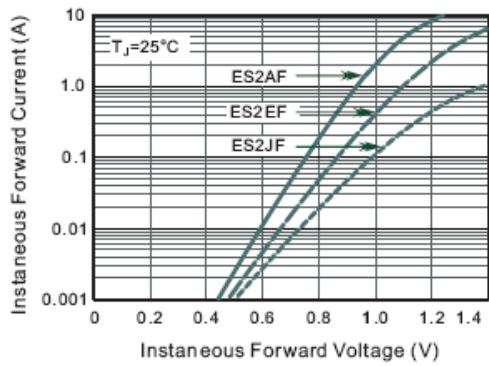


Fig.3 Typical Reverse Characteristics

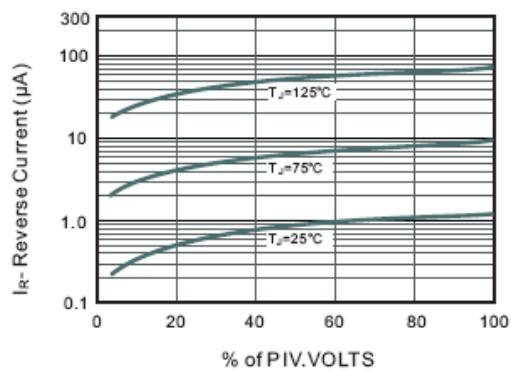
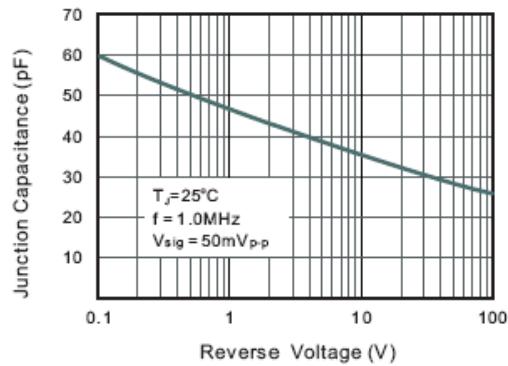


Fig.5 Typical Junction Capacitance



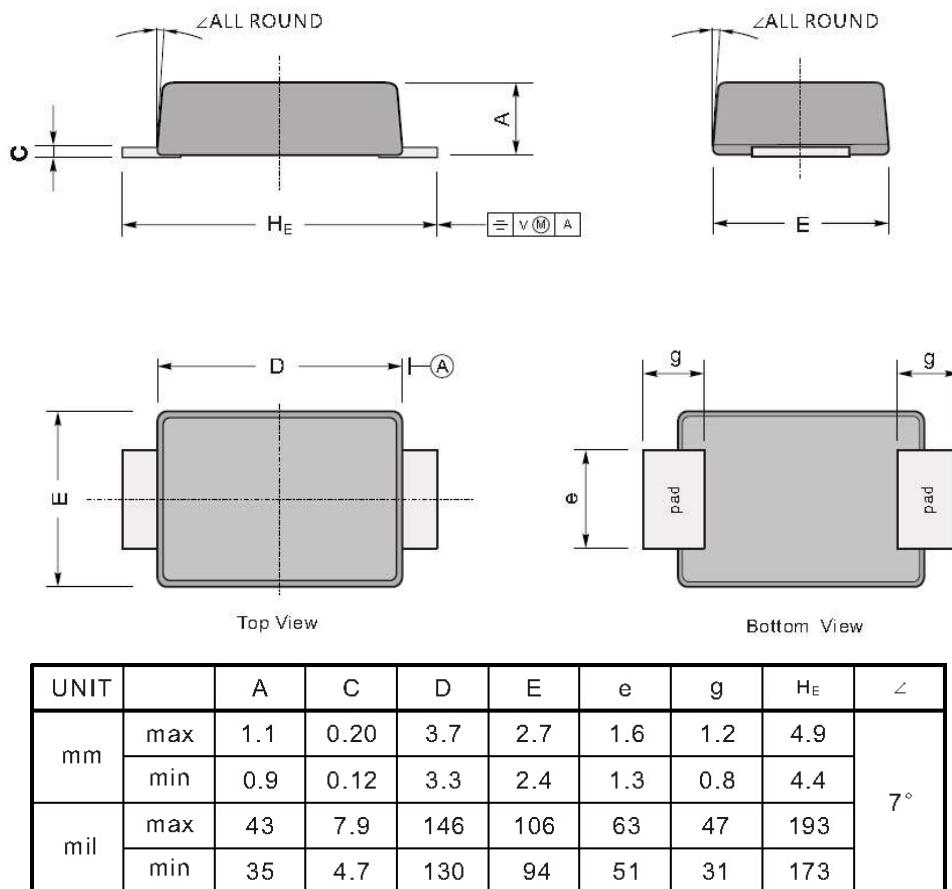
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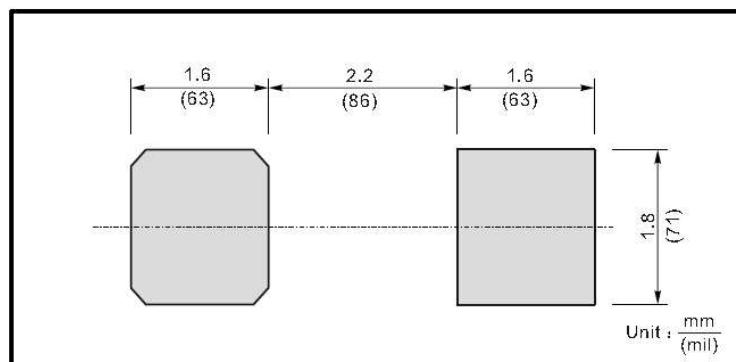
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMAF



The recommended mounting pad size



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